

☆TDK Multilayer Ceramic Chip Capacitors

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Creation Date: March 13, 2014

C3216X7R2J102K115AA (TDK item description : C3216X7R2J102KT****)

Applications



Commercial Grade



Please refer to Part No. CGA5H4X7R2J102K115AA for automotive use.

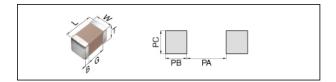
Feature



Mid Voltage (100 to 630V)

Series

C3216 [EIA CC1206]











Size		
Length(L)	3.20mm +/-0.20mm	
Width(W)	1.60mm +/-0.20mm	
Thickness(T)	1.15mm +/-0.15mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	1.00mm Min.	
Recommended Land Pattern(PA)	2.10 to 2.50mm (Flow Soldering) < br /> 2.00 to 2.40mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	1.10 to 1.30mm (Flow Soldering) < br />1.00 to 1.20mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	1.00 to 1.30mm (Flow Soldering) < br />1.10 to 1.60mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	1nF +/-10%	
Rated Voltage	630Vdc	
Temperature Characteristic	X7R(+/-15%)	
Dissipation Factor	3% Max.	
Insulation Resistance	10000MΩ Min.	

Other	
Soldering Method	Reflow, Flow
AEC Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000 Pcs Min.

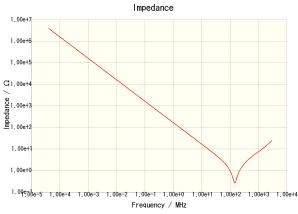
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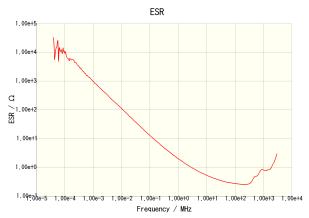
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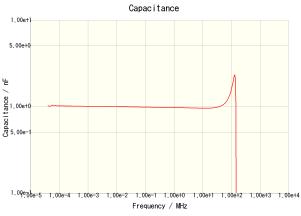
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



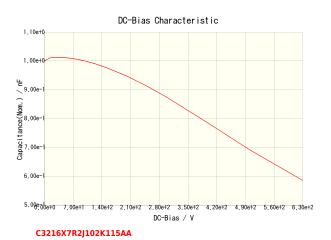


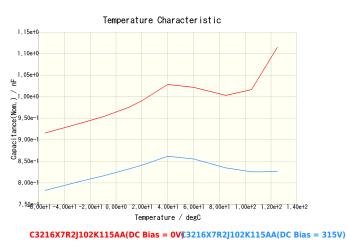


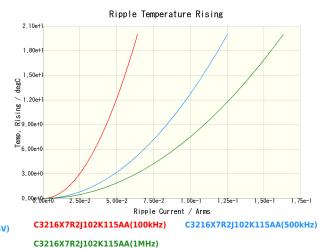
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